

MOS FIELD EFFECT TRANSISTOR

2SK2137

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2137 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

- Low On-Resistance
2SK2137: $R_{DS(on)} = 2.4 \Omega$ ($V_{GS} = 10 \text{ V}$, $I_D = 2.0 \text{ A}$)
- Low C_{iss} $C_{iss} = 550 \text{ pF TYP.}$
- High Avalanche Capability Ratings
- Isolate TO-220 Package

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

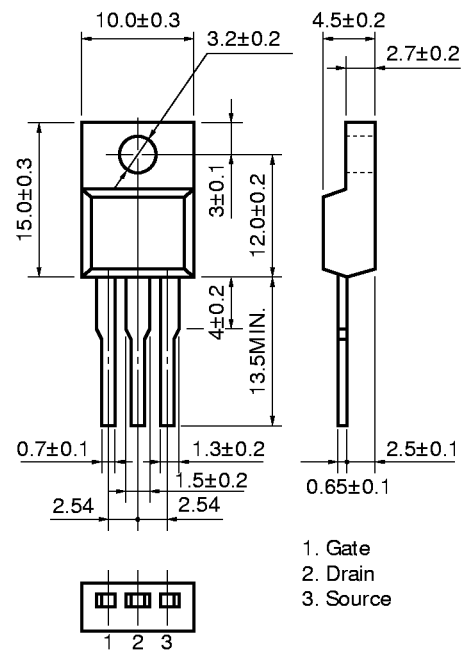
Drain to Source Voltage	V_{DSS}	600	V
Gate to Source Voltage	V_{GSS}	± 30	V
Drain Current (DC)	$I_{D(DC)}$	± 4.0	A
Drain Current (pulse)*	$I_{D(pulse)}$	± 16	A
Total Power Dissipation ($T_c = 25^\circ\text{C}$)	P_{T1}	30	W
Total Power Dissipation ($T_A = 25^\circ\text{C}$)	P_{T2}	2.0	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to $+150$	$^\circ\text{C}$
Single Avalanche Current**	I_{AS}	4.0	A
Single Avalanche Energy**	E_{AS}	5.3	mJ

* $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$

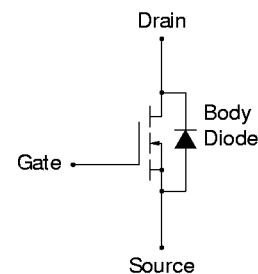
** Starting $T_{ch} = 25^\circ\text{C}$, $R_G = 25 \Omega$, $V_{GS} = 20 \text{ V} \rightarrow 0$

PACKAGE DIMENSIONS

(in millimeters)



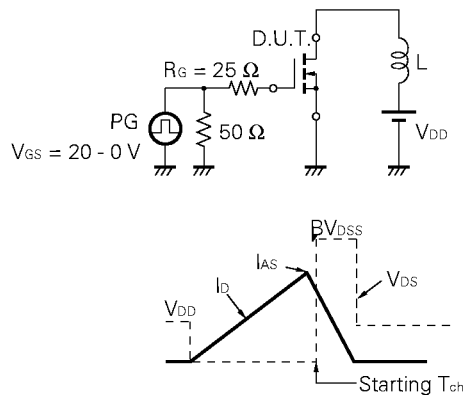
MP-45F (ISOLATED TO-220)



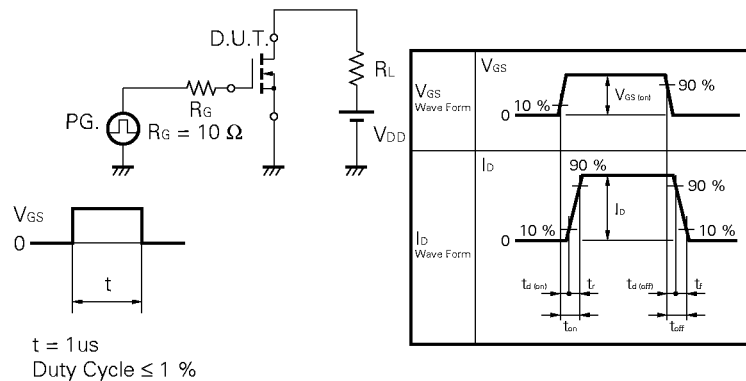
ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-State Resistance	R _{DS(on)}		1.7	2.4	Ω	V _{GS} = 10 V, I _D = 2.0 A
Gate to Source Cutoff Voltage	V _{GS(off)}	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	y _{fs}	1.0			S	V _{DS} = 10 V, I _D = 2.0 A
Drain Leakage Current	I _{DSS}			100	μA	V _{DS} = V _{DSS} , V _{GS} = 0
Gate to Source Leakage Current	I _{GSS}			±100	nA	V _{GS} = ±30 V, V _{DS} = 0
Input Capacitance	C _{iss}		550		pF	V _{DS} = 10 V V _{GS} = 0 f = 1 MHz
Output Capacitance	C _{oss}		130		pF	
Reverse Transfer Capacitance	C _{rss}		25		pF	
Turn-On Delay Time	t _{d(on)}		11		ns	I _D = 2.0 A V _{GS(on)} = 10 V V _{DD} = 150 V R _G = 10 Ω R _L = 75 Ω
Rise Time	t _r		6		ns	
Turn-Off Delay Time	t _{d(off)}		45		ns	
Fall Time	t _f		7		ns	
Total Gate Charge	Q _G		20		nC	I _D = 4.0 A V _{DD} = 480 V V _{GS} = 10 V
Gate to Source Charge	Q _{GS}		4		nC	
Gate to Drain Charge	Q _{GD}		10		nC	
Body Diode Forward Voltage	V _{F(S-D)}		1.0		V	I _F = 4.0 A, V _{GS} = 0
Reverse Recovery Time	t _{rr}		320		ns	I _F = 4.0 A, V _{GS} = 0 di/dt = 50 A/μs
Reverse Recovery Charge	Q _{rr}		1.2		μC	

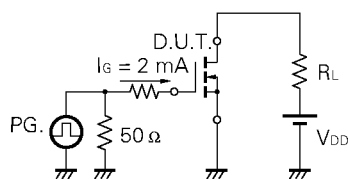
Test Circuit 1 Avalanche Capability



Test Circuit 2 Switching Time

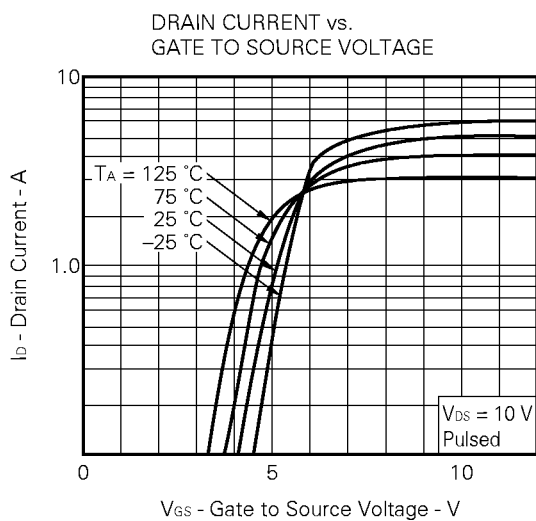
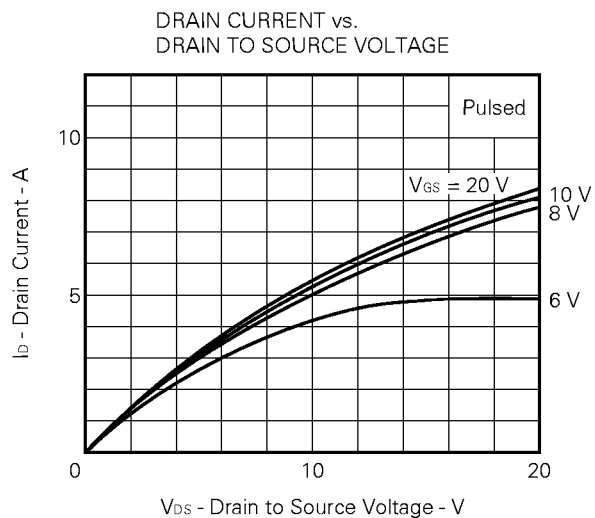
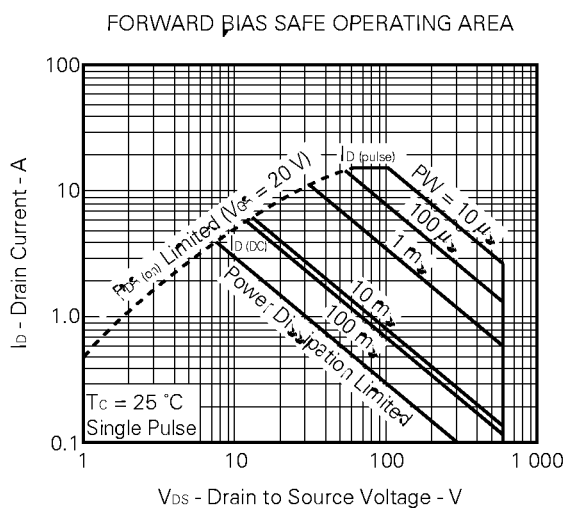
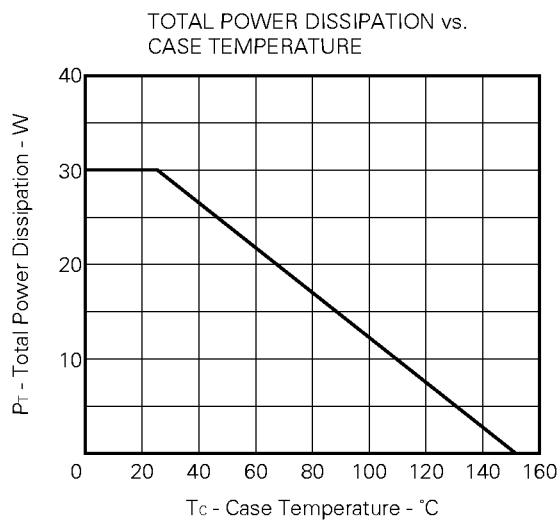
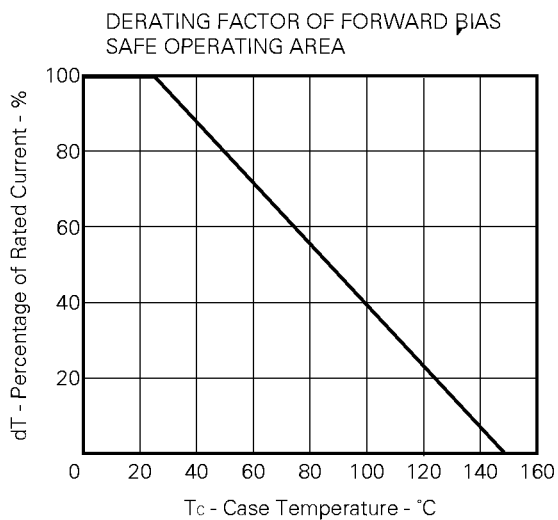


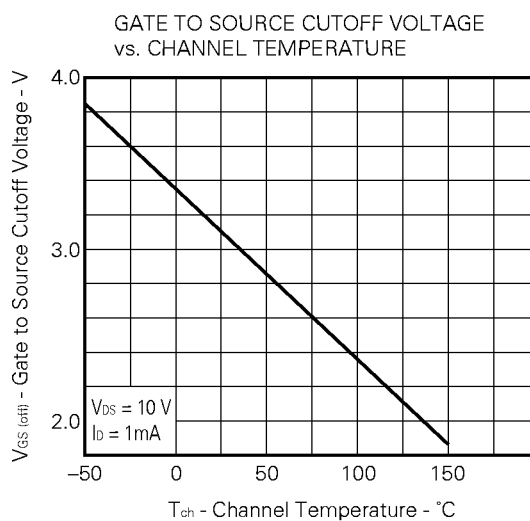
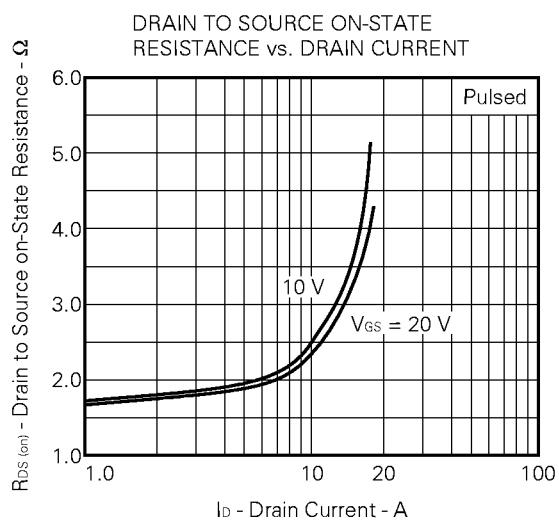
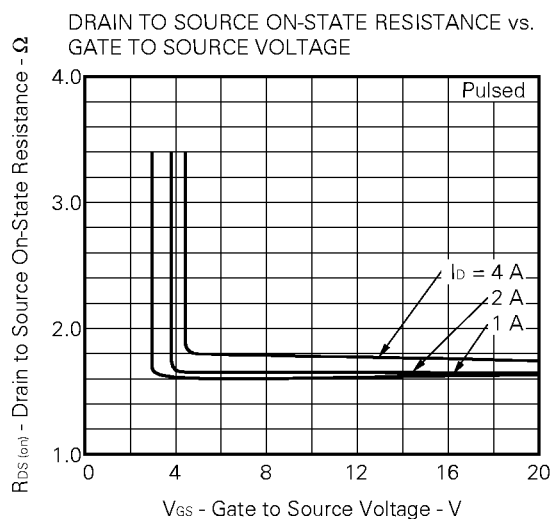
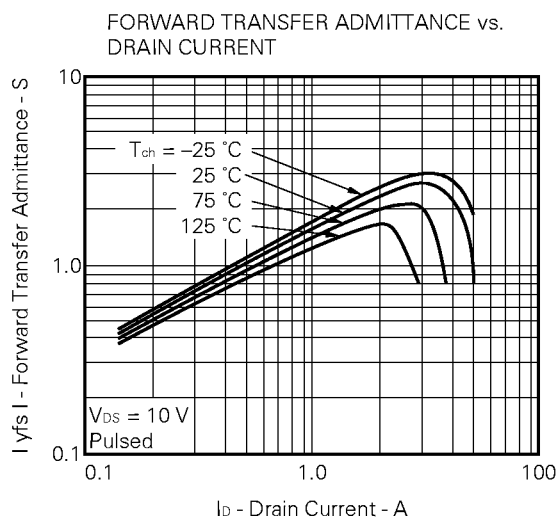
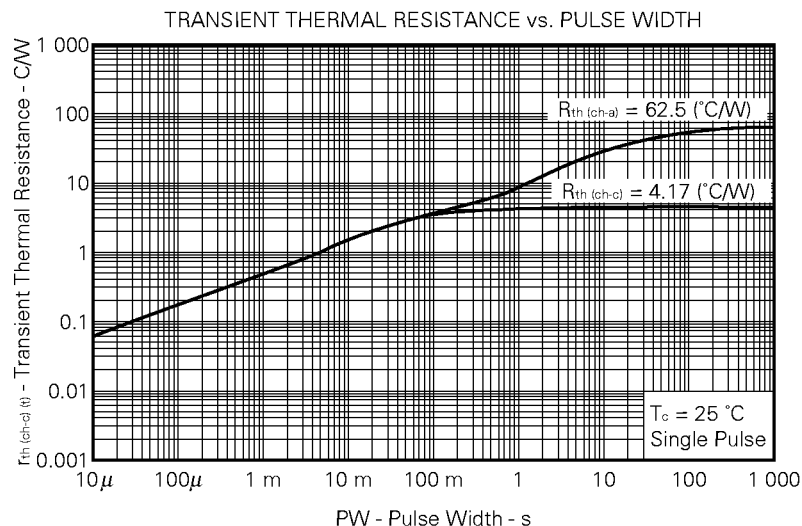
Test Circuit 3 Gate Charge



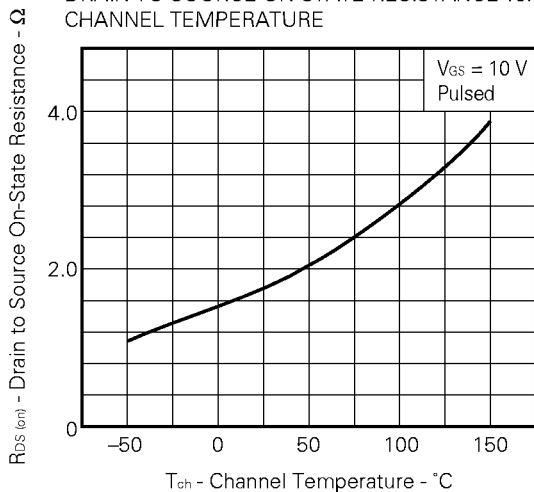
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

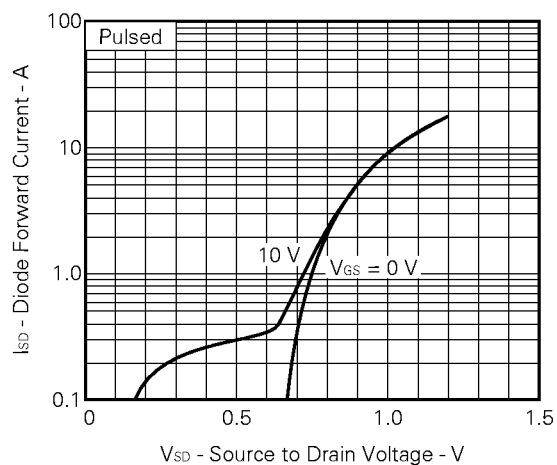




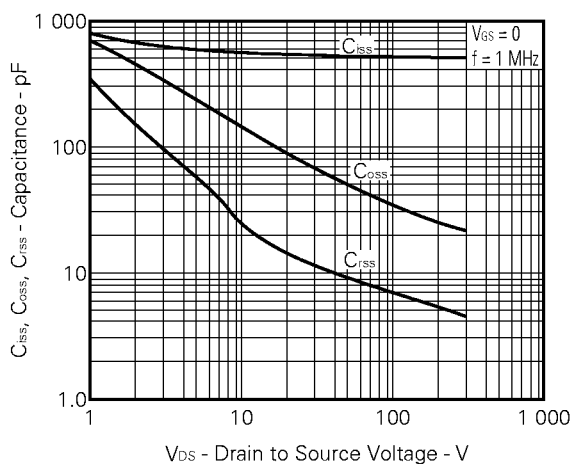
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



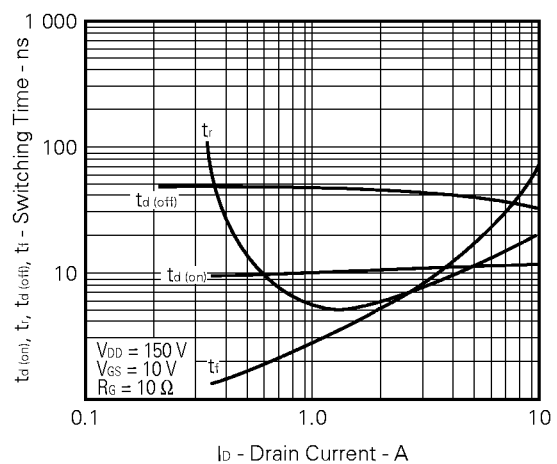
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



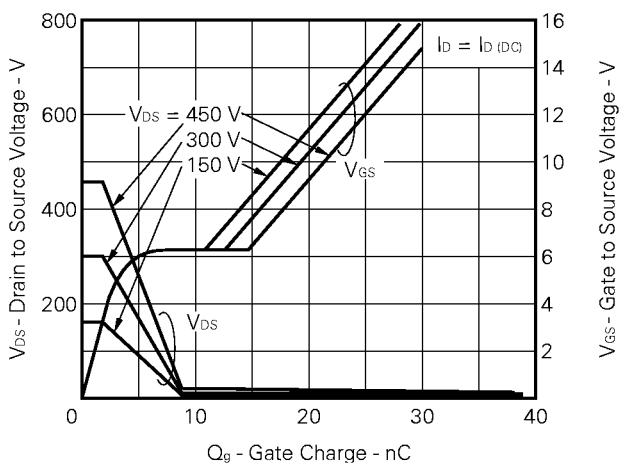
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



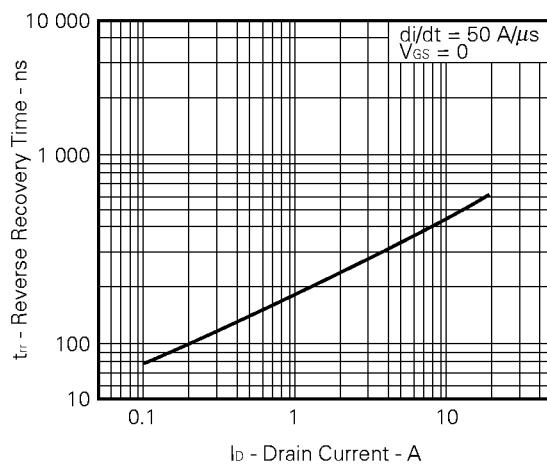
SWITCHING CHARACTERISTICS



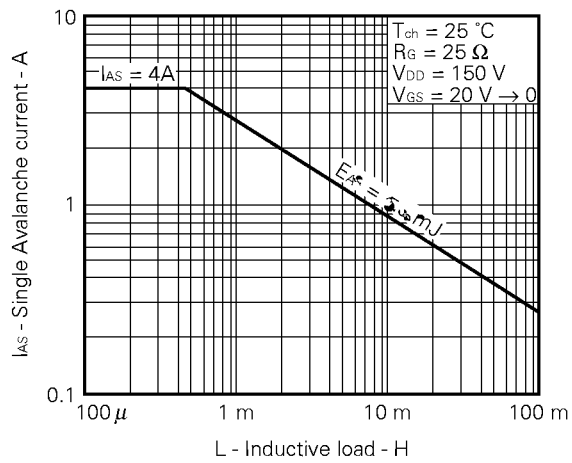
DYNAMIC INPUT CHARACTERISTICS



REVERSE RECOVERY TIME vs. DRAIN CURRENT



SINGLE AVALANCHE CURRENT vs.
INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY vs.
STARTING CHANNEL TEMPERATURE

